

November 2013

## FQT2P25

## P-Channel QFET® MOSFET

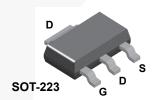
-250 V, -0.55 A, 4.0  $\Omega$ 

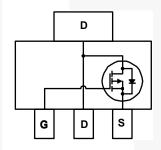
## **Description**

These P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters.

#### **Features**

- -0.55 A, -250 V, R<sub>DS(on)</sub> = 4.0  $\Omega$  (Max.) @ V<sub>GS</sub> = -10 V, I<sub>D</sub> = -0.275 A
- Low Gate Charge (Typ. 6.5 nC)
- Low Crss (Typ. 6.5 pF)
- · 100% Avalanche Tested





## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter		FQT2P25TF	Unit
V <sub>DSS</sub>	Drain-Source Voltage		-250	V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°C)		-0.55	А
	- Continuous (T <sub>C</sub> = 100°	°C)	-0.35	Α
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	-2.2	А
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	120	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	-0.55	Α
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	0.25	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3		-5.5	V/ns
$P_{D}$	Power Dissipation (T <sub>C</sub> = 25°C)		2.5	W
	- Derate above 25°C		0.02	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
T <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

### **Thermal Characteristics**

Symbol	Parameter	FQT2P25TF	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *	50	°C/W

<sup>\*</sup> When mounted on the minimum pad size recommended (PCB Mount)

## **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQT2P25TF	FQT2P25	SOT-223	Tape and Reel	13 "	12 mm	4000 units

## **Electrical Characteristics** T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	racteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-250			V
$\Delta B_{VDSS}/$ $\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D$ = -250 μA, Referenced to 25°C		-0.2		V/°C
I <sub>DSS</sub>	Zara Cata Valtaga Prain Current	V <sub>DS</sub> = -250 V, V <sub>GS</sub> = 0 V			-1	μΑ
	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -200 V, T <sub>C</sub> = 125°C			-10	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V			-100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V			100	nA
On Cha	racteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	-3.0		-5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -0.275 A		3.15	4.0	Ω
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = -40 \text{ V}, I_{D} = -0.275 \text{ A}$		0.6		S
	ic Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$		190	250	pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		40	55	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			6.5	8.5	pF
Switchi	ing Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = -125 V, I <sub>D</sub> = -2.3 A,		8.5	25	ns
t <sub>r</sub>	Turn-On Rise Time	$R_G = 25 \Omega$		40	90	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	- · · · · · · · · · · · · · · · · · · ·		12	35	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)		25	60	ns
Qg	Total Gate Charge	V <sub>DS</sub> = -200 V, I <sub>D</sub> = -2.3 A,		6.5	8.5	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = -10 V	/	1.8		nC
Q <sub>gd</sub>	Gate-Drain Charge	(Note 4)		3.0		nC
\ \						
Drain-S	ource Diode Characteristics a	nd Maximum Ratings				
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				-0.55	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				-2.2	Α
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = -0.55 \text{ A}$			-5.0	V
trr	Reverse Recovery Time	$V_{GS} = 0 \text{ V, } I_{S} = -2.3 \text{ A,}$		110	//	ns
Qrr	Reverse Recovery Charge	$dI_F / dt = 100 A/\mu s$		0.4		μС

- Notes: 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. L = 635 mH,  $I_{AS}$  = -0.55 A,  $V_{DD}$  = -50 V,  $R_G$  = 25  $\Omega$ , starting  $T_J$  = 25°C. 3.  $I_{SD}$  ≤ -2.3 A, di/dt ≤ 300 A/µs,  $V_{DD}$  ≤ BV<sub>DSS</sub>, starting  $T_J$  = 25°C. 4. Essentially independent of operating temperature.

## **Typical Characteristics**

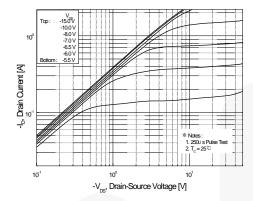


Figure 1. On-Region Characteristics

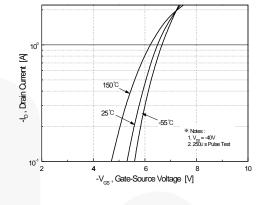


Figure 2. Transfer Characteristics

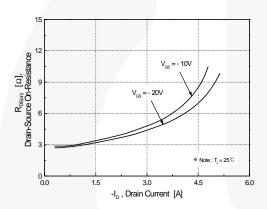


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

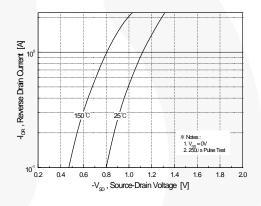


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

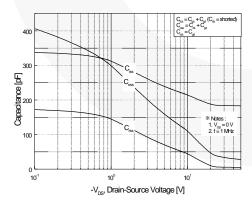


Figure 5. Capacitance Characteristics

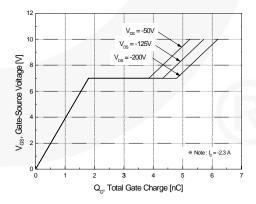


Figure 6. Gate Charge Characteristics

## Typical Characteristics (Continued)

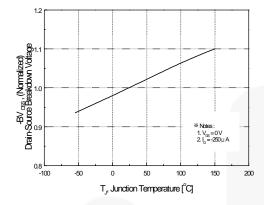


Figure 7. Breakdown Voltage Variation vs. Temperature

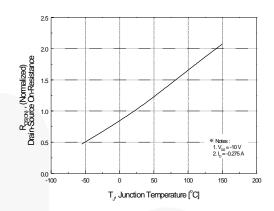


Figure 8. On-Resistance Variation vs. Temperature

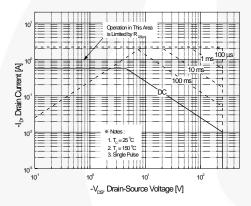


Figure 9. Maximum Safe Operating Area

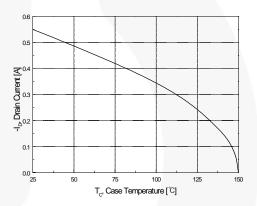


Figure 10. Maximum Drain Current vs. Case Temperature

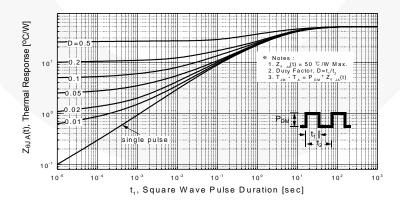


Figure 11. Transient Thermal Response Curve

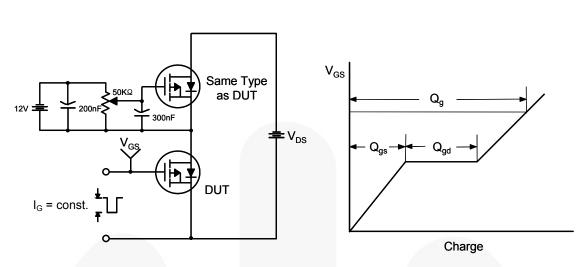


Figure 12. Gate Charge Test Circuit & Waveform

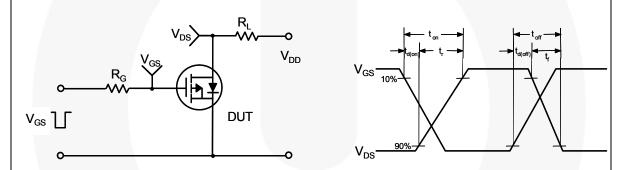


Figure 13. Resistive Switching Test Circuit & Waveforms

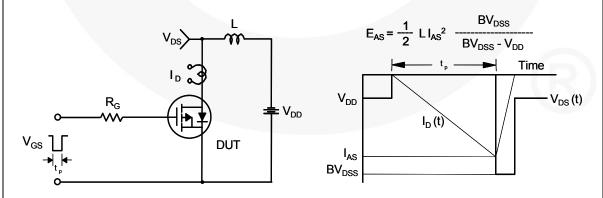
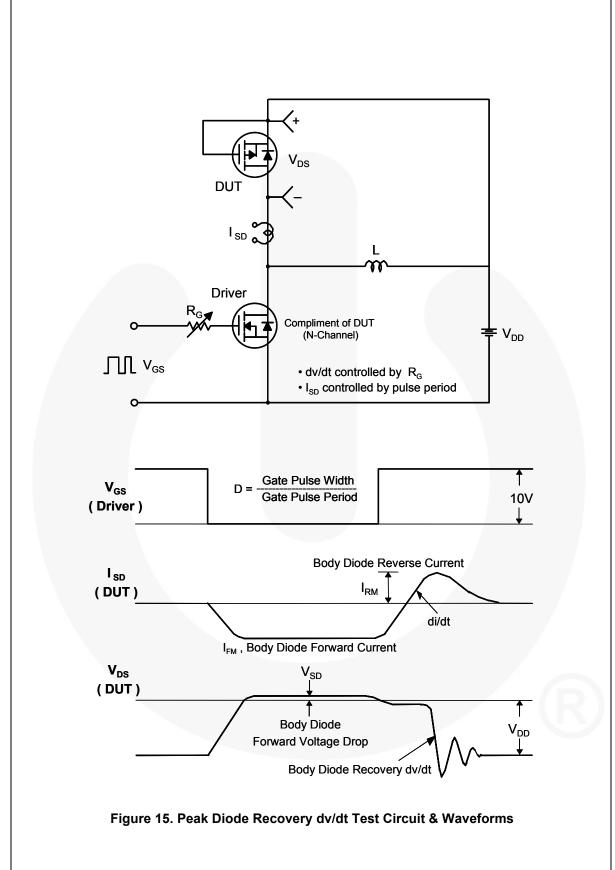


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



## **Mechanical Dimensions**

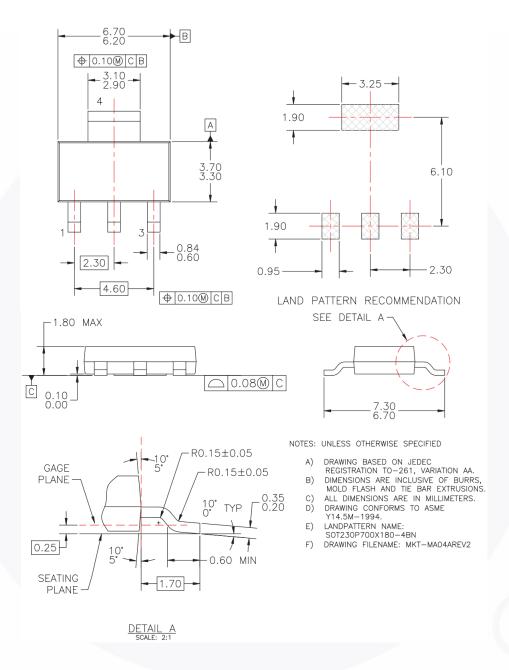


Figure 16. SOT-223, Molded, 4-Lead

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Rev. 166

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